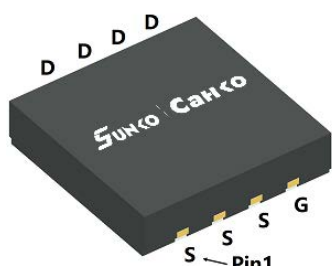
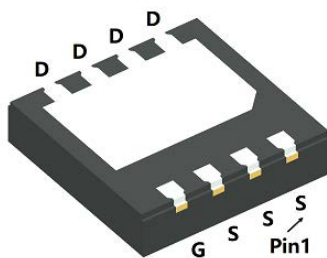


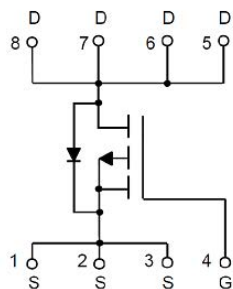
P-Channel Enhancement Mode Field Effect Transistor



Top View



Bottom View



DFN3333-8L-WF

Product Summary

- V_{DS} -100V
- I_D -16A
- $R_{DS(ON)}$ (at $V_{GS}=-10V$) <85m Ω
- $R_{DS(ON)}$ (at $V_{GS}=-4.5V$) <102m Ω
- 100% EAS Tested
- 100% ∇V_{DS} Tested

General Description

- Trench Power MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Load switch
- Motor drive control
- DC-DC convertor

■ Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter			Symbol	Limit	Unit
Drain-source Voltage			V_{DS}	-100	V
Gate-source Voltage			V_{GS}	±20	V
Continuous Drain Current (Note 1,2)	Steady-State	$T_A=25^{\circ}\text{C}$, $V_{GS}= -10\text{V}$	I_D	-3.3	A
		$T_A=100^{\circ}\text{C}$, $V_{GS}= -10\text{V}$		-2	
Continuous Drain Current (Note 1,3)	Steady-State	$T_C=25^{\circ}\text{C}$, $V_{GS}= -10\text{V}$		-16	
		$T_C =100^{\circ}\text{C}$, $V_{GS}= -10\text{V}$		-10	
Pulsed Drain Current	$T_C=25^{\circ}\text{C}$, $t_p=100\mu\text{s}$		I_{DM}	-60	A
Avalanche energy	$V_G=-10\text{V}$, $R_G=25\Omega$, $L=1\text{mH}$, $I_{AS}=-12.6\text{A}$		EAS	79.38	mJ
Total Power Dissipation (Note 1,2)	Steady-State	$T_A=25^{\circ}\text{C}$	P_D	1.92	W
		$T_A=100^{\circ}\text{C}$		0.76	
Total Power Dissipation (Note 1,3)	Steady-State	$T_C=25^{\circ}\text{C}$		56	
		$T_C =100^{\circ}\text{C}$		22	
Junction and Storage Temperature Range			T_J, T_{STG}	-55~+150	°C

■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient (Note 2)	Steady-State	$R_{\theta JA}$	52	65	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	1.8	2.2	

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SCQ085P10A	F1	Q085P10A	5000	10000	100000	13" reel

SCQ085P10A

■ Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =-250μA	-100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V, V _{GS} =0V	-	-	-1	μA
		V _{DS} =-100V, V _{GS} =0V, T _j =150°C	-	-	-100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =-250μA	-1.5	-2	-2.5	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-10A	-	66	85	mΩ
		V _{GS} =-4.5V, I _D =-10A	-	74	102	
Diode Forward Voltage	V _{SD}	I _S =-10A, V _{GS} =0V	-	-	-1.2	V
Gate resistance	R _G	f=1MHz	-	11.5	-	Ω
Maximum Body-Diode Continuous Current	I _S		-	-	-16	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =-50V, V _{GS} =0V, f=1MHz	-	2040	-	pF
Output Capacitance	C _{oss}		-	90	-	
Reverse Transfer Capacitance	C _{rss}		-	70	-	
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =-10V, V _{DS} =-50V, I _D =-10A	-	44.4	-	nC
Gate-Source Charge	Q _{gs}		-	4.7	-	
Gate-Drain Charge	Q _{gd}		-	5.5	-	
Reverse Recovery Charge	Q _{rr}	I _F =-10A, di/dt=100A/us	-	45	-	nC
Reverse Recovery Time	t _{rr}		-	30	-	ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =-10V, V _{DD} =-50V, I _D =-10A R _{GEN} =3Ω	-	9	-	ns
Turn-on Rise Time	t _r		-	42	-	
Turn-off Delay Time	t _{D(off)}		-	91	-	
Turn-off fall Time	t _f		-	31	-	

Note:

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
2. The value of R_{θJA} is measured with the device mounted on the 40mm*40mm*1.1mm single layer FR-4 PCB board with 1 in² pad of 2oz. Copper, in the still air environment with T_A =25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
3. Thermal resistance from junction to soldering point (on the exposed drain pad).

■ Typical Electrical and Thermal Characteristics Diagrams

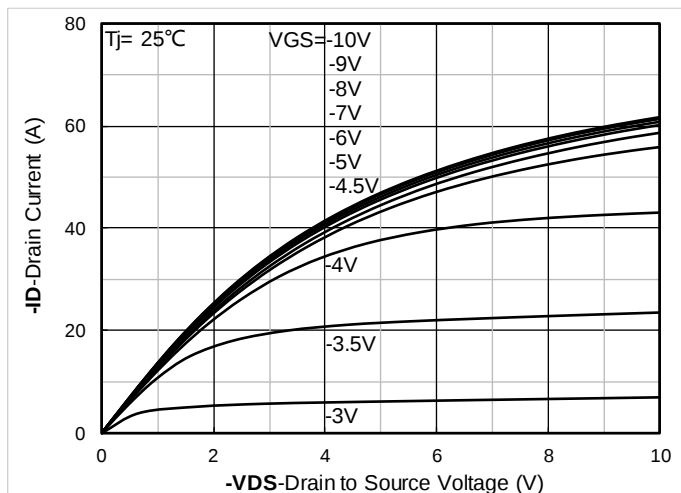


Figure 1. Output Characteristics

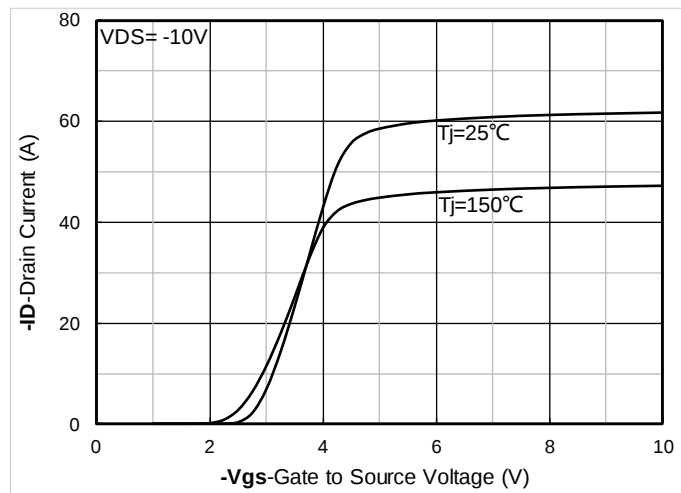


Figure 2. Transfer Characteristics

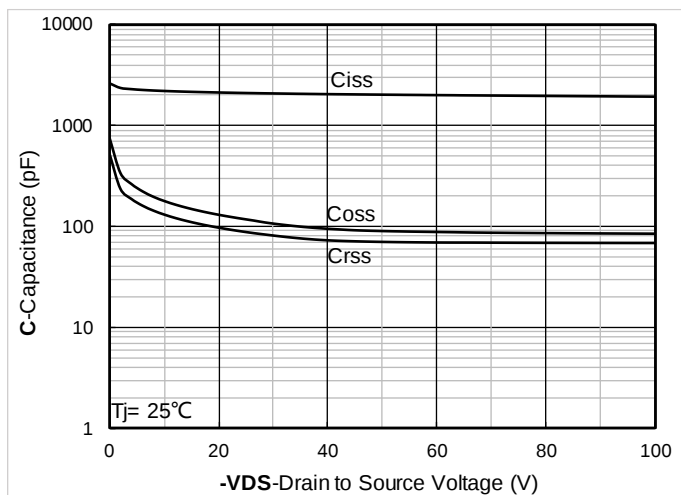


Figure 3. Capacitance Characteristics

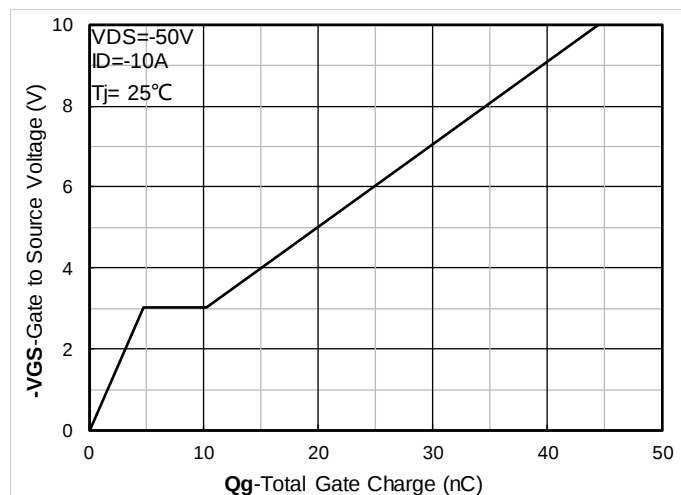


Figure 4. Gate Charge

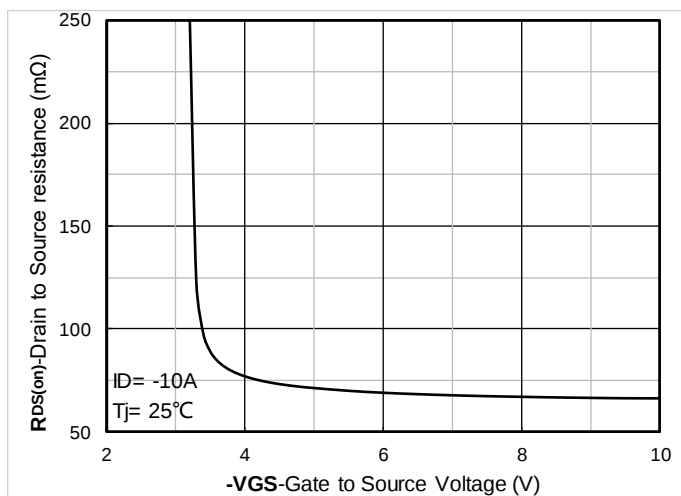


Figure 5. On-Resistance vs Gate to Source Voltage

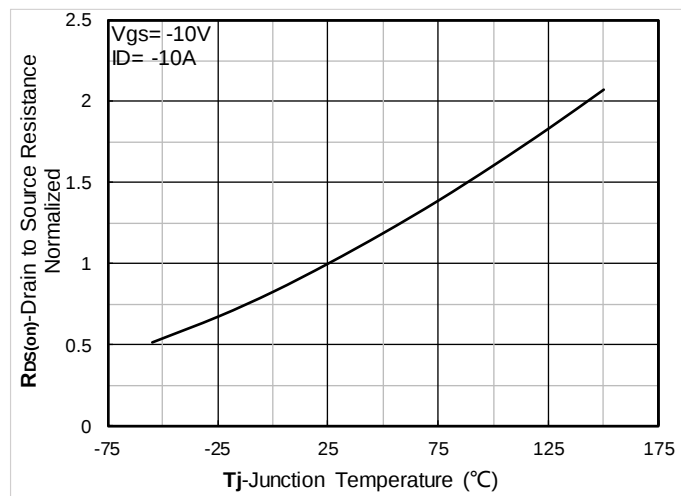


Figure 6. Normalized On-Resistance

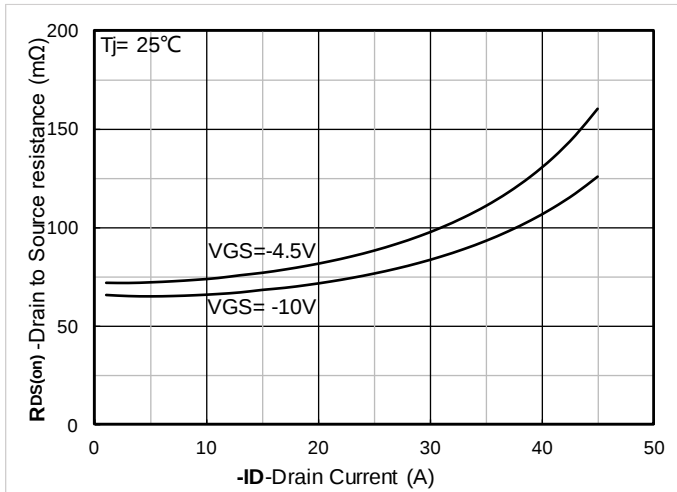


Figure 7. $R_{DS(on)}$ VS Drain Current

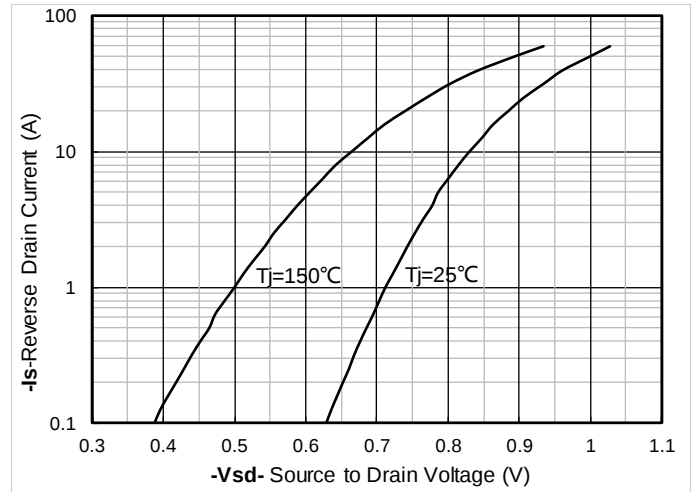


Figure 8. Forward characteristics of reverse diode

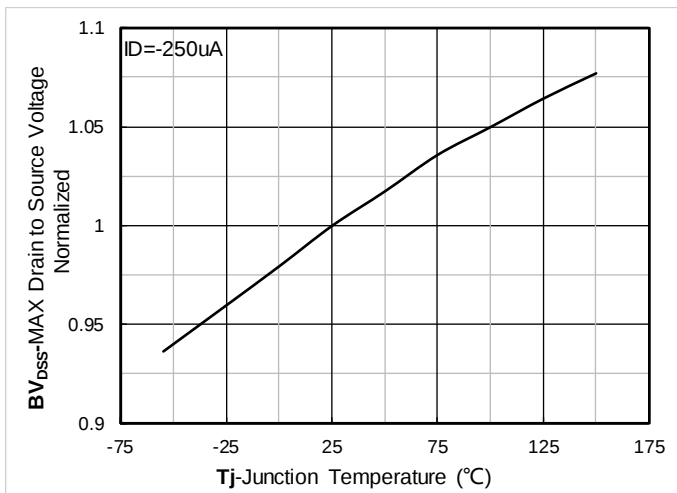


Figure 9. Normalized breakdown voltage

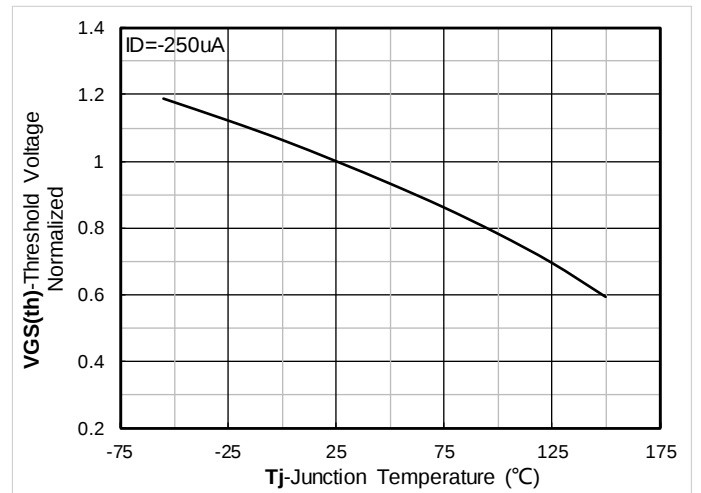


Figure 10. Normalized Threshold voltage

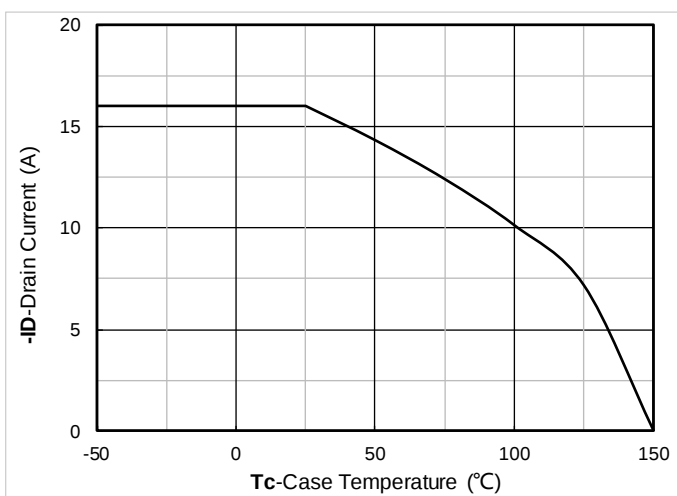


Figure 11. Current dissipation

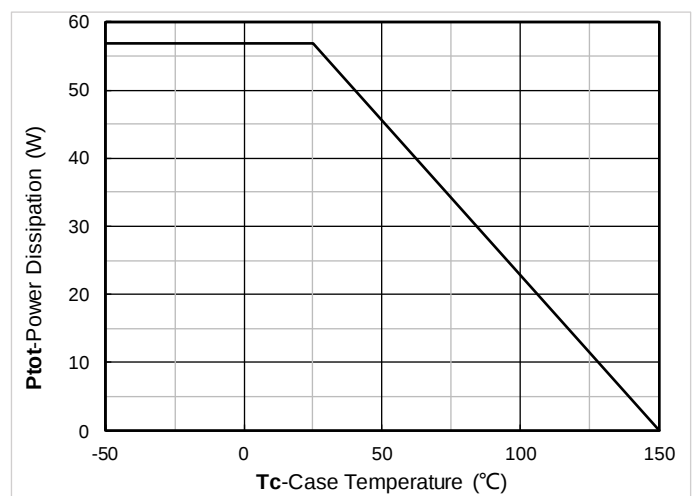


Figure 12. Power dissipation

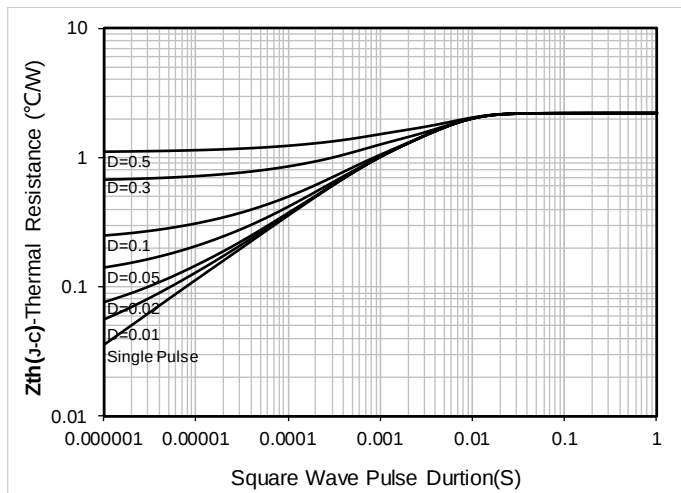


Figure 13. Maximum Transient Thermal Impedance

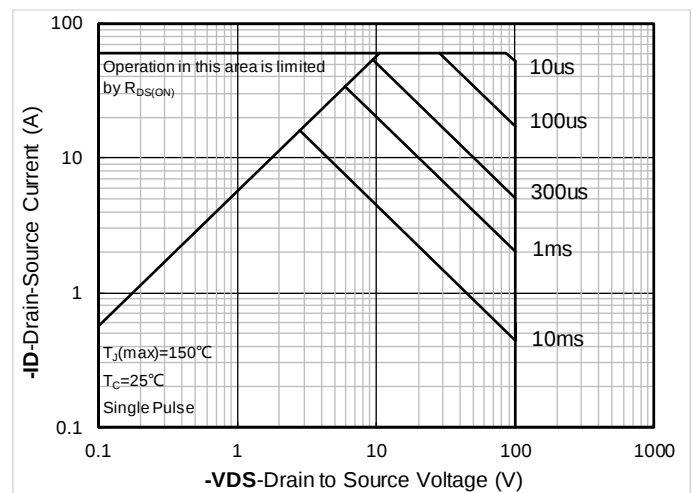
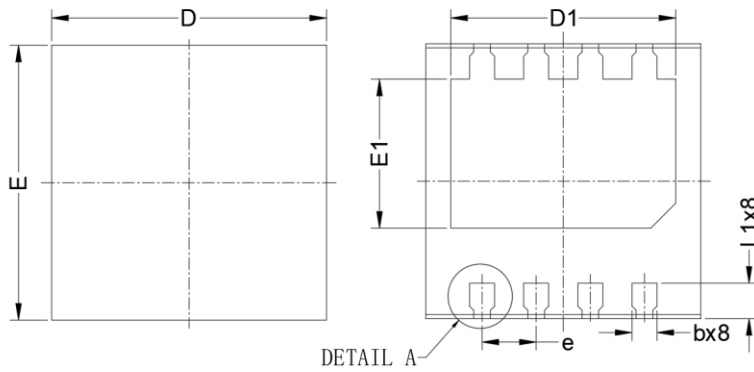


Figure 14. Safe Operation Area

■ DFN3333-8L-WF Package information



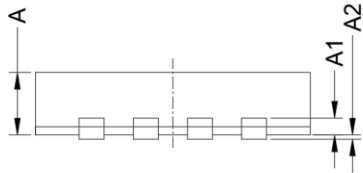
Top View
正面视图

Bottom View
背面视图

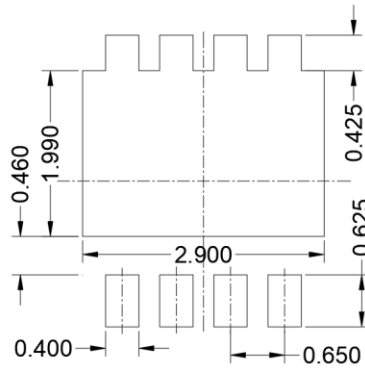
SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	3.30 BSC		
E	3.30 BSC		
A	0.70	0.75	0.80
A1	0.203 BSC		
A2			0.10
D1	2.60	2.70	2.80
E1	1.69	1.79	1.89
L1	0.325	0.425	0.525
b	0.20	0.30	0.40
e	0.65 BSC		

Note:

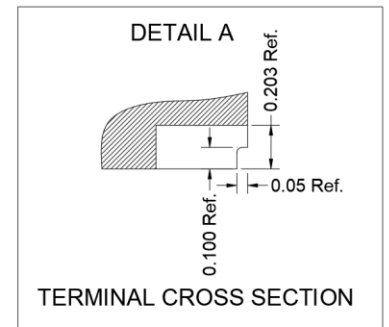
1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.10 mm.
3. The pad layout is for reference purposes only.



Side View
侧面视图



Suggested Solder Pad Layout
Top View



Disclaimer

The information presented in this document is for reference only. Shanghai Sunco Electronics Co., Ltd reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices). Russiansunco or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website <http://www.russiansunco.co> or consult your nearest Russiansunco's sales office for further assistance.